



# Driver Transistors

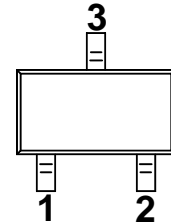


## PNP Silicon

### MAXIMUM RATINGS

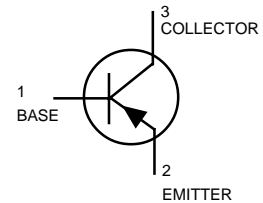
Rating	Symbol	Value		Unit
		MMBTA55	MMBTA56	
Collector–Emitter Voltage	$V_{CEO}$	-60	-80	Vdc
Collector–Base Voltage	$V_{CBO}$	-60	-80	Vdc
Emitter–Base Voltage	$V_{EBO}$	-4.0		Vdc
Collector Current — Continuous	$I_C$	-500		mAdc

SOT-23 (TO-236AB)



### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	225	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C/W}$
Total Device Dissipation Alumina Substrate, (2) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	300	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C/W}$
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$



### DEVICE MARKING

MMBTA55 = 2H; MMBTA56 = 2GM

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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### OFF CHARACTERISTICS

Collector–Emitter Breakdown Voltage (3) ( $I_C = -1.0 \text{ mAdc}, I_B = 0$ )	$V_{(BR)CEO}$	-60	—	Vdc
	MMBTA55	-60	—	
	MMBTA56	-80	—	
Emitter–Base Breakdown Voltage ( $I_E = -100 \mu\text{Adc}, I_C = 0$ )	$V_{(BR)EBO}$	-4.0	—	Vdc
Collector Cutoff Current ( $V_{CE} = -60\text{Vdc}, I_B = 0$ )	$I_{CEO}$	—	-0.1	$\mu\text{Adc}$
Collector Cutoff Current ( $V_{CB} = -60\text{Vdc}, I_E = 0$ )	$I_{CBO}$	—	-0.1	$\mu\text{Adc}$
	MMBTA55	—	-0.1	
	MMBTA56	—	-0.1	

- FR-5 =  $1.0 \times 0.75 \times 0.062$  in.
- Alumina =  $0.4 \times 0.3 \times 0.024$  in. 99.5% alumina.
- Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

# ELECTRICAL CHARACTERISTICS

## MMBTA55/56

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
<b>ON CHARACTERISTICS</b>				
DC Current Gain ( $I_C = -10\text{ mAdc}$ , $V_{CE} = -1.0\text{ Vdc}$ ) ( $I_C = -100\text{ mAdc}$ , $V_{CE} = -1.0\text{ Vdc}$ )	$h_{FE}$	100 100	— —	—
Collector–Emitter Saturation Voltage ( $I_C = -100\text{ mAdc}$ , $I_B = -10\text{ mAdc}$ )	$V_{CE(sat)}$	—	-0.25	Vdc
Base–Emitter On Voltage ( $I_C = -100\text{ mAdc}$ , $V_{CE} = -1.0\text{ Vdc}$ )	$V_{BE(on)}$	—	-1.2	Vdc
<b>SMALL–SIGNAL CHARACTERISTICS</b>				
Current –Gain–Bandwidth Product(4) ( $V_{CE} = -1.0\text{ Vdc}$ , $I_C = -100\text{ mAdc}$ , $f = 100\text{ MHz}$ )	$f_T$	50	—	MHz

4.  $f_T$  is defined as the frequency at which  $|h_{fe}|$  extrapolates to unity.

# PACKAGE OUTLINE & DIMENSIONS

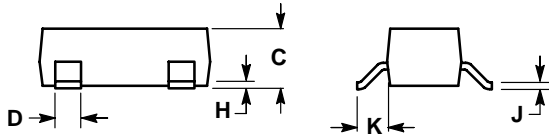
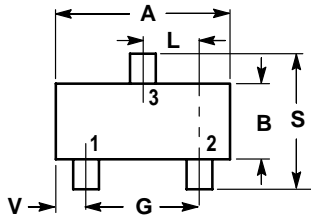
## MMBTA55/56

### SOT-23

#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982

2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

